Low-power inverting buffer with open-drain and inverterRev. 1 — 23 November 2012Product data

Product data sheet

General description 1.

The 74AUP2G0604 is a single inverting buffer with open-drain output and a single inverter. It features two input pins (nA), an output pin (2Y) and an open-drain output pin (1Y).

Schmitt trigger action at all inputs makes the circuit tolerant of slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. **Features and benefits**

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - JESD8-11 (0.9 V to 1.65 V)
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \,\mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Low-power inverting buffer with open-drain and inverter

Ordering information 3.

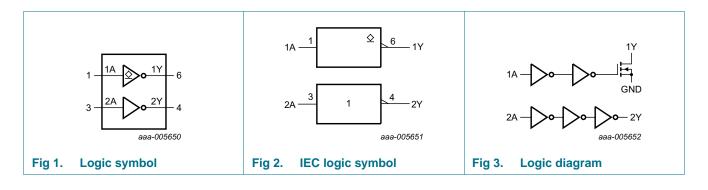
Table 1. Ordering info	ormation							
Type number	Package	Package						
	Temperature range Name		Description	Version				
74AUP2G0604GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363				
74AUP2G0604GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886				
74AUP2G0604GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm	SOT891				
74AUP2G0604GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 \times 1.0 \times 0.35 mm	SOT1115				
74AUP2G0604GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0\times1.0\times0.35$ mm	SOT1202				

Marking 4.

Table 2. Marking	
Type number	Marking code ^[1]
74AUP2G0604GW	a6
74AUP2G0604GM	a6
74AUP2G0604GF	a6
74AUP2G0604GN	a6
74AUP2G0604GS	a6

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

Functional diagram 5.

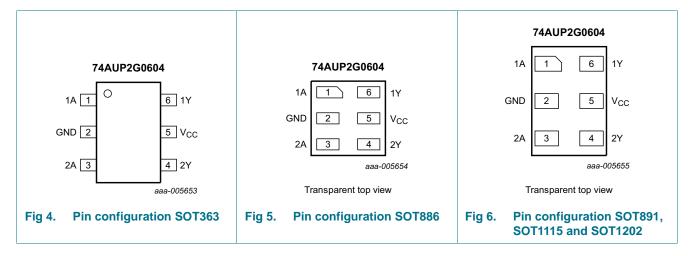


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6. Pinning information

6.1 Pinning



6.2 Pin description

SymbolPinDescription1A1data inputGND2ground (0 V)2A3data input2Y4data outputV _{CC} 5supply voltage1Y6data output	Table 3.	Pin description	
GND2ground (0 V)2A3data input2Y4data outputV _{CC} 5supply voltage	Symbol	Pin	Description
2A3data input2Y4data outputV _{CC} 5supply voltage	1A	1	data input
2Y 4 data output V _{CC} 5 supply voltage	GND	2	ground (0 V)
V _{CC} 5 supply voltage	2A	3	data input
	2Y	4	data output
1Y 6 data output	V _{CC}	5	supply voltage
	1Y	6	data output

7. Functional description

Table 4. Function table^[1]

Input	Output
1A	1Y
L	Z
н	L

[1] H = HIGH voltage level; L = LOW voltage level.

Table 5.Function table

Input	Output
2A	2Y
L	Н
Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

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8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CC}			
		1Y	-	+20	mA
		2Y	-	±20	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2] _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SC-88 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 7. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC}	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V _{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 0.8 V \text{ to } 3.6 V$	0	200	ns/V

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10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C					
VIH	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70 \times V_{\text{CC}}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
/IL LOW-level input voltage		$V_{CC} = 0.8 V$	-	-	$0.30\times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	V
V _{OH}	HIGH-level output voltage	2Y; $V_I = V_{IH}$ or V_{IL}				
		I_{O} = –20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_0 = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75\times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
V _{OL}	LOW-level output voltage	1Y, 2Y; $V_I = V_{IH}$ or V_{IL}				
		I_{O} = 20 $\mu A; V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3\times V_{CC}$	V
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		$I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.31	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
I _I	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μΑ
I _{OFF}	power-off leakage current	V_{I} or V_{O} = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.2	μΑ
ΔI_{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.2	μΑ
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \text{ to } 3.6 \ V \end{array}$	-	-	0.5	μΑ
Δl _{CC}	additional supply current		-	-	40	μΑ
CI	input capacitance	$V_{CC} = 0$ V to 3.6 V; $V_I = GND$ or V_{CC}	-	0.8	-	pF

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Co	output capacitance	$V_O = GND; V_{CC} = 0 V$				
		1Y output; enabled	-	1.7	-	pF
		1Y output; disabled	-	1.1	-	pF
		2Y output	-	1.7	-	pF
T _{amb} = –	40 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30\times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35\times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V
/ _{он}	HIGH-level output voltage	2Y; $V_I = V_{IH}$ or V_{IL}				
		I_{O} = -20 μ A; V_{CC} = 0.8 V to 3.6 V	V _{CC} - 0.1	-	-	V
		$I_0 = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.7 \times V_{CC}$	-	-	V
		$I_0 = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.03	-	-	V
		$I_0 = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.30	-	-	V
		$I_0 = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
		$I_0 = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
		$I_0 = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
V _{OL}	LOW-level output voltage	1Y, 2Y; $V_{I} = V_{IH}$ or V_{IL}				
02		$I_0 = 20 \ \mu\text{A}; V_{CC} = 0.8 \ \text{V to } 3.6 \ \text{V}$	-	-	0.1	V
		$I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.37	V
		$I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.35	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.45	V
1	input leakage current	$V_{I} = GND \text{ to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.5	μA
OFF	power-off leakage current	$V_{\rm I}$ or $V_{\rm O} = 0$ V to 3.6 V; $V_{\rm CC} = 0$ V	-	-	±0.5	μΑ
	additional power-off leakage current	$V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	-	-	±0.6	μA
сс	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = O \ A; \\ V_{CC} = O.8 \ V \ to \ 3.6 \ V \end{array}$	-	-	0.9	μΑ
∆l _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	-	-	50	μA

Table 8. Static characteristics ...continued

Low-power inverting buffer with open-drain and inverter

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	40 °C to +125 °C					
√ _{IH}	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.75 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.70\times V_{CC}$	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
√ _{IL}	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.25\times V_{CC}$	V
		$V_{CC} = 0.9 \text{ V}$ to 1.95 V	-	-	$0.30\times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V	-	-	0.9	V
V _{он}	HIGH-level output voltage	2Y; $V_I = V_{IH}$ or V_{IL}				
		I_{O} = –20 $\mu\text{A};V_{CC}$ = 0.8 V to 3.6 V	V _{CC} – 0.11	-	-	V
		$I_0 = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.6\times V_{CC}$	-	-	V
		$I_0 = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.17	-	-	V
		I_{O} = -2.3 mA; V_{CC} = 2.3 V	1.77	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V
√ _{OL}	LOW-level output voltage	1Y, 2Y; $V_I = V_{IH}$ or V_{IL}				
		I_O = 20 $\mu A;V_{CC}$ = 0.8 V to 3.6 V	-	-	0.11	V
		$I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.33\times V_{CC}$	V
		I_{O} = 1.7 mA; V_{CC} = 1.4 V	-	-	0.41	V
		I_{O} = 1.9 mA; V_{CC} = 1.65 V	-	-	0.39	V
		I_{O} = 2.3 mA; V_{CC} = 2.3 V	-	-	0.36	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.50	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		I_{O} = 4.0 mA; V_{CC} = 3.0 V	-	-	0.50	V
I	input leakage current	$V_{\rm I}$ = GND to 3.6 V; $V_{\rm CC}$ = 0 V to 3.6 V	-	-	±0.75	μΑ
OFF	power-off leakage current	V_{I} or V_{O} = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.75	μΑ
∆I _{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.75	μA
СС	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = O \ A; \\ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \end{array}$	-	-	1.4	μA
∆l _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	-	-	75	μA

Table 8. Static characteristics ... continued

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Low-power inverting buffer with open-drain and inverter

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	Conditions		25 °C			–40 °C to +125 °C			Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	_
C _L = 5 pF	F									
pd	propagation	1A to 1Y or 2A to 2Y; see Figure 7	[2]							
	delay	$V_{CC} = 0.8 V$		-	14.4	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V}$ to 1.3 V		2.3	4.7	10.3	2.0	11.4	12.6	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		1.8	3.4	6.4	1.5	7.4	8.2	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.5	2.9	5.0	1.2	5.9	6.5	ns
		V_{CC} = 2.3 V to 2.7 V		1.2	2.3	3.9	1.0	4.5	5.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.1	2.2	3.3	0.8	3.9	4.3	ns
C _L = 10 p	ρF									
pd	propagation	1A to 1Y or 2A to 2Y; see Figure 7	[2]							
	delay	$V_{CC} = 0.8 V$		-	17.7	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V}$ to 1.3 V		2.7	5.7	12.2	2.5	13.7	15.1	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		2.2	4.1	7.5	2.0	8.7	9.6	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.9	3.6	5.9	1.7	7.0	7.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.7	2.9	4.6	1.4	5.4	6.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.6	3.0	4.6	1.2	4.9	5.4	ns
C _L = 15 p	ρF									
pd	propagation	1A to 1Y or 2A to 2Y; see Figure 7	[2]							
	delay	$V_{CC} = 0.8 V$		-	21.1	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V}$ to 1.3 V		3.2	6.6	13.0	2.9	15.8	17.4	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		2.6	4.7	8.6	2.3	10.0	11.0	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		2.3	4.3	6.7	2.1	8.0	8.8	ns
		V_{CC} = 2.3 V to 2.7 V		2.1	3.4	5.1	1.7	6.1	6.8	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.0	3.6	6.0	1.5	6.5	7.2	ns
C _L = 30 p	ρF									
pd	propagation	1A to 1Y or 2A to 2Y; see Figure 7	[2]							
	delay	$V_{CC} = 0.8 V$		-	30.7	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		4.4	9.1	16.5	3.9	19.3	21.3	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		3.6	6.6	10.8	3.2	12.9	14.2	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		3.2	6.1	10.7	2.9	11.0	12.1	ns
		V_{CC} = 2.3 V to 2.7 V		2.9	4.9	7.2	2.6	7.8	8.6	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		2.9	5.4	10.5	2.5	10.8	11.9	ns
		V_{CC} = 2.3 V to 2.7 V		2.9	4.9	7.2	2.6	7.8	8	3.6

Low-power inverting buffer with open-drain and inverter

Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	r Conditions		25 °C			–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 p	F, 10 pF, 15 p	F and 30 pF							
C _{PD}	power	1A to 1Y; $f_i=1$ MHz; $V_1 = GND$ to V_{CC} [3][4]							
	dissipation	$V_{CC} = 0.8 V$	-	0.5	-	-	-	-	pF
	capacitance	V _{CC} = 1.1 V to 1.3 V	-	0.6	-	-	-	-	pF
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	0.7	-	-	-	-	pF
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	0.7	-	-	-	-	pF
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	-	1.0	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	1.2	-	-	-	-	pF
		2A to 2Y; $f_i=1$ MHz; $V_1 = GND$ to V_{CC} [3][5]							
		$V_{CC} = 0.8 V$	-	2.5	-	-	-	-	pF
		V _{CC} = 1.1 V to 1.3 V	-	2.7	-	-	-	-	pF
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	2.8	-	-	-	-	pF
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	3.0	-	-	-	-	pF
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	-	3.5	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	4.0	-	-	-	-	pF

- [1] All typical values are measured at nominal V_{CC} .
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} (2A to 2Y) and t_{PLZ} and t_{PZL} (1A to 1Y).
- [3] All specified values are the average typical values over all stated loads.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 P_{D} = $C_{PD} \times V_{CC}{}^2 \times f_i \times N$ where:

 f_i = input frequency in MHz;

 C_L = load capacitance in pF;

N = number of inputs switching;

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

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12. Waveforms

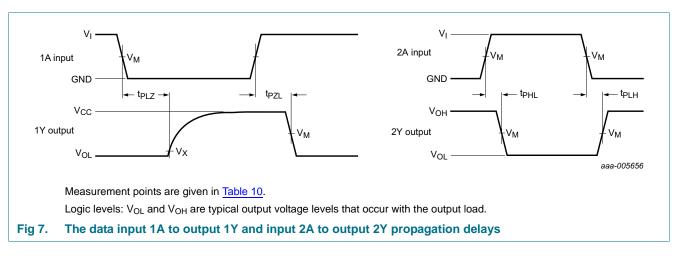


Table 10. Measurement points

Supply voltage	Output	Output		Input		
V _{CC}	V _M	V _X	V _M	VI	t _r = t _f	
0.8 V to 1.6 V	$0.5\times V_{CC}$	V _{OL} + 0.1 V	$0.5\times V_{CC}$	V _{CC}	≤ 3.0 ns	
1.65 V to 2.7 V	$0.5\times V_{CC}$	V _{OL} + 0.15 V	$0.5\times V_{CC}$	V _{CC}	\leq 3.0 ns	
3.0 V to 3.6 V	$0.5\times V_{CC}$	V _{OL} + 0.3 V	$0.5\times V_{CC}$	V _{CC}	\leq 3.0 ns	

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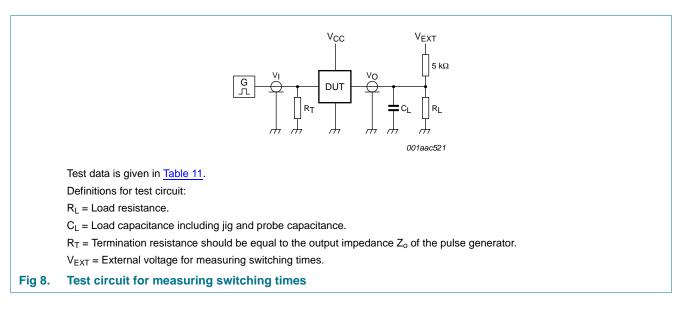


Table 11. Test data

Supply voltage	Load	V _{EXT}			
V _{CC}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2\times V_{CC}$

[1] For measuring enable and disable times, $R_L = 5 \text{ k}\Omega$. For measuring propagation delays, set-up and hold times, and pulse width, $R_L = 1 \text{ M}\Omega$.

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13. Package outline

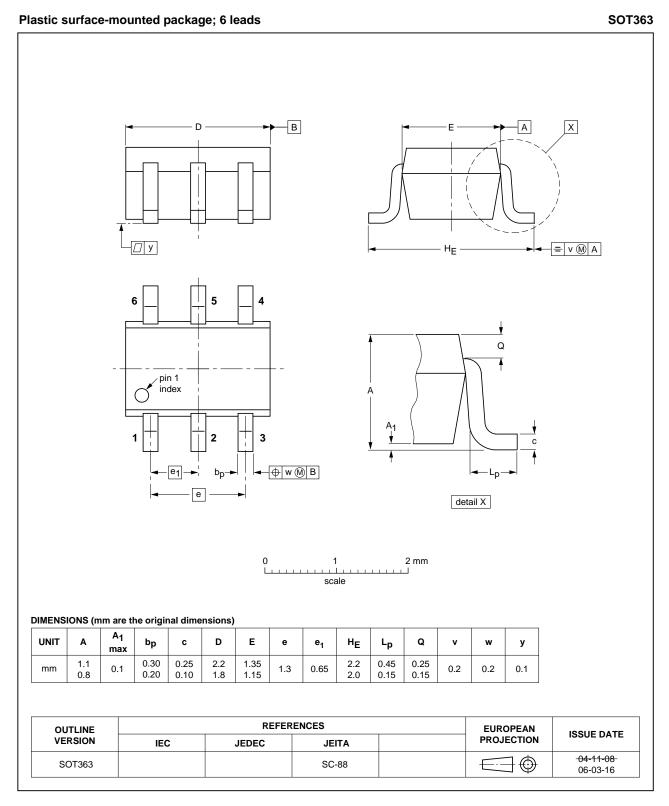


Fig 9. Package outline SOT363 (SC-88)

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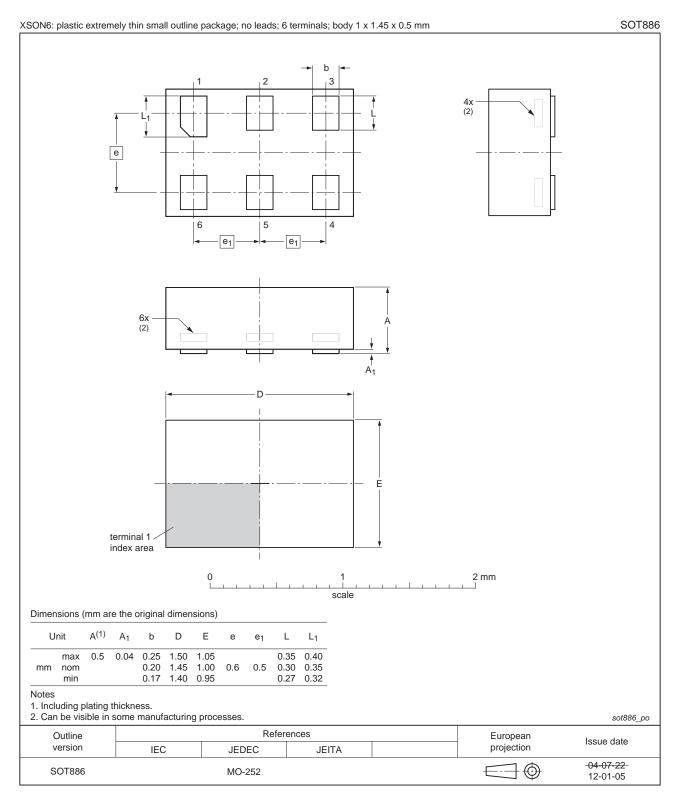


Fig 10. Package outline SOT886 (XSON6)

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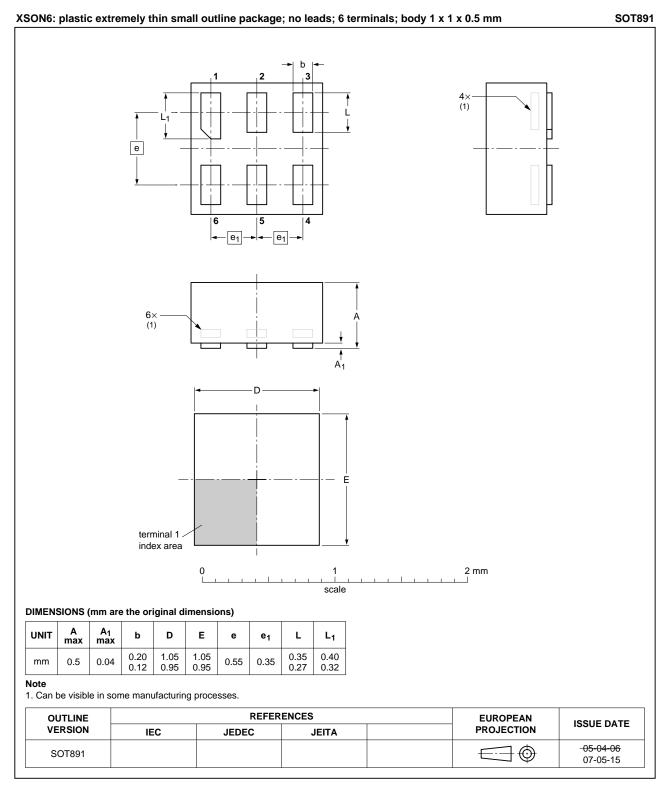
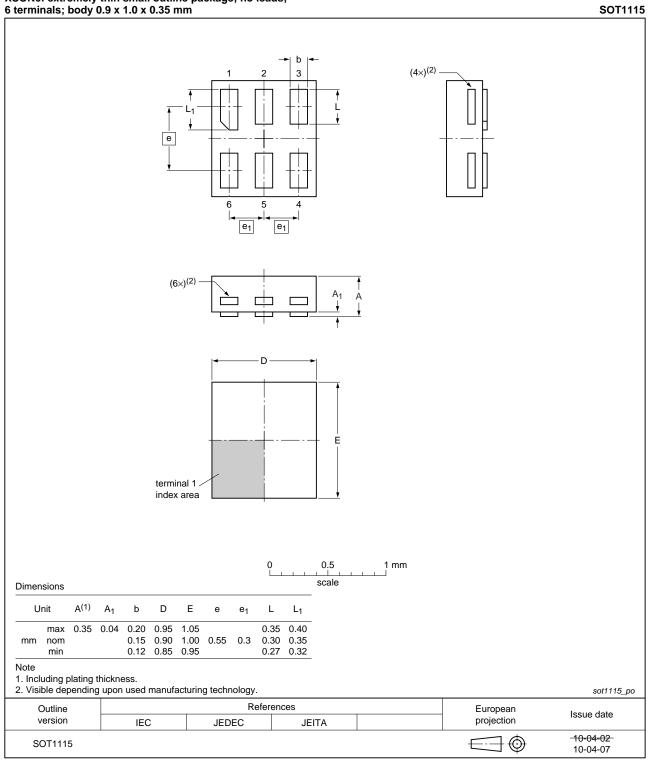


Fig 11. Package outline SOT891 (XSON6)

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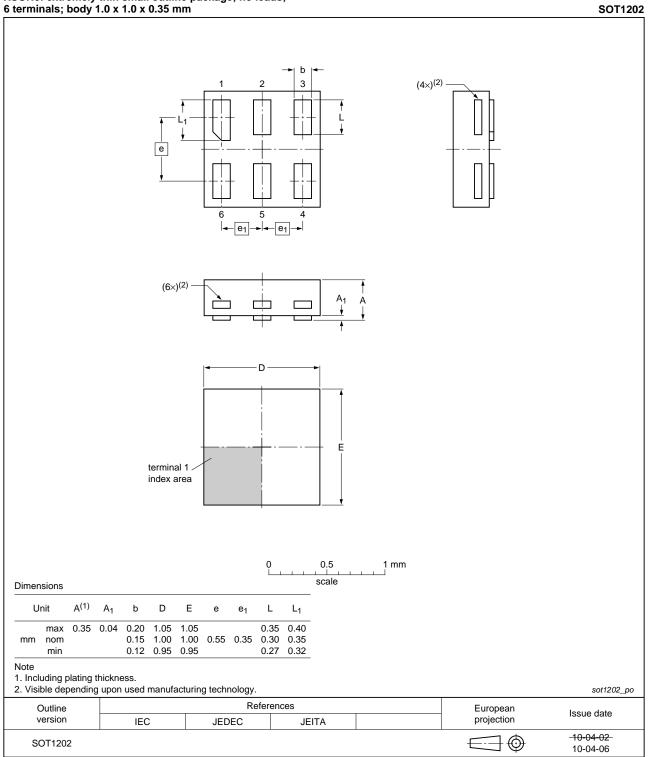


XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 12. Package outline SOT1115 (XSON6)

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XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 13. Package outline SOT1202 (XSON6)

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14. Abbreviations

Table 12.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 13. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP2G0604 v.1	20121123	Product data sheet	-	-

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16. Legal information

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Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions".

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